

## AD7823

### FEATURES

**8-Bit ADC with 4  $\mu$ s Conversion Time**  
**Small Footprint 8-Lead microSOIC Package**  
**Specified Over a  $-40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$  Temperature Range**  
**Inherent Track-and-Hold Functionality**  
**Operating Supply Range: 2.7 V to 5.5 V**  
**Specifications at 2.7 V to 5.5 V and 5 V  $\pm$  10%**  
**Microcontroller Compatible Serial Interface**  
**Optional Automatic Power-Down**  
**Low Power Operation:**  
     570  $\mu$ W at 10 kSPS Throughput Rate  
     2.9 mW at 50 kSPS Throughput Rate  
**Analog Input Range: 0 V to  $V_{\text{REF}}$**   
**Reference Input Range: 0 V to  $V_{\text{DD}}$**   
**"Drop In" Upgrade to 10 Bits Available (AD7810)**

### APPLICATIONS

**Low Power, Hand-Held Portable Applications**  
**Requiring Analog-to-Digital Conversion**  
**with 8-Bit Accuracy, e.g.,**  
     **Battery-Powered Test Equipment**  
     **Battery-Powered Communications Systems**

### GENERAL DESCRIPTION

The AD7823 is a high speed, low power, 8-bit A/D converter that operates from a single 2.7 V to 5.5 V supply. The part contains a 4  $\mu$ s typ successive approximation A/D converter, inherent track-and-hold functionality (with a pseudo differential input) and a high speed serial interface that interfaces to most microcontrollers. The AD7823 is fully specified over a temperature range of  $-40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$ .

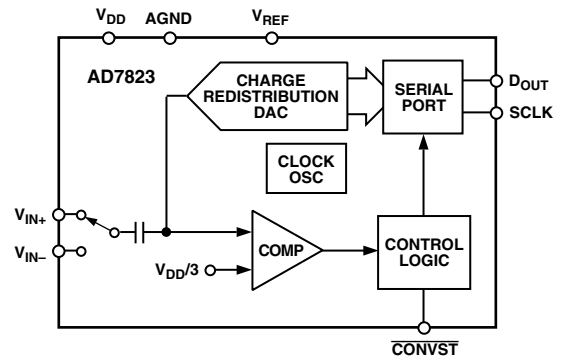
By using a technique that samples the state of the  $\overline{\text{CONVST}}$  (convert start) signal at the end of a conversion, the AD7823 may be used in an automatic power-down mode. When used in this mode, the AD7823 powers down automatically at the end of a conversion and "wakes up" at the start of a new conversion. This feature significantly reduces the power consumption of the part at lower throughput rates. The AD7823 can also operate in a high speed mode where the part is not powered down between conversions. In this high speed mode of operation, the conversion time of the AD7823 is 4  $\mu$ s typ. The maximum throughput rate is dependent on the speed of the serial interface of the microcontroller.

The part is available in a small, 8-lead 0.3" wide, plastic dual-in-line package (mini-DIP); in an 8-lead, small outline IC (SOIC); and in an 8-lead microSOIC package.

### REV. C

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### FUNCTIONAL BLOCK DIAGRAM



### PRODUCT HIGHLIGHTS

- Complete, 8-Bit ADC in 8-Lead Package**  
 The AD7823 is an 8-bit 4  $\mu$ s typ ADC with inherent track-and-hold functionality and a high speed serial interface—all in an 8-lead microSOIC package.  $V_{\text{REF}}$  may be connected to  $V_{\text{DD}}$  to eliminate the need for an external reference. The result is a high speed, low power, space saving ADC solution.
- Low Power, Single Supply Operation**  
 The AD7823 operates from a single 2.7 V to 5.5 V supply and typically consumes only 9 mW of power. The power dissipation can be significantly reduced at lower throughput rates by using the automatic power-down mode, e.g., at a throughput rate of 10 kSPS the power consumption is only 570  $\mu$ W.
- Automatic Power-Down**  
 The automatic power-down mode, whereby the AD7823 "powers down" at the end of a conversion and "wakes up" before the next conversion, means the AD7823 is ideal for battery powered applications. See Power vs. Throughput Rate section.
- Serial Interface**  
 An easy to use, fast serial interface allows connection to most popular microprocessors with no external circuitry.

# AD7823\* Product Page Quick Links

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### **Data Sheet**

- AD7823: 2.7 V to 5.5 V, 4.5 ms, 8-Bit ADC in 8-Lead microSOIC/DIP Data Sheet

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### **Technical Articles**

- MS-2210: Designing Power Supplies for High Speed ADC

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# AD7823—SPECIFICATIONS (GND = 0 V, V<sub>REF</sub> = V<sub>DD</sub>. All specifications –40°C to +125°C unless otherwise noted.)

| Parameter   | Y Version              | Unit           | Test Conditions/Comments                                  |
|---|------------------------|----------------|---|
| <b>DYNAMIC PERFORMANCE</b>                                      |                        |                |   |
| Signal to (Noise + Distortion) Ratio <sup>1,2</sup>             | 48                     | dB min         | f <sub>IN</sub> = 30 kHz, f <sub>SAMPLE</sub> = 133 kHz   |
| Total Harmonic Distortion <sup>1</sup>                          | –70                    | dB typ         |   |
| Peak Harmonic or Spurious Noise <sup>1</sup>                    | –70                    | dB typ         |   |
| Intermodulation Distortion <sup>2</sup>                         |                        |                | f <sub>a</sub> = 48 kHz, f <sub>b</sub> = 48.5 kHz        |
| 2nd Order Terms   | –77                    | dB typ         |   |
| 3rd Order Terms   | –77                    | dB typ         |   |
| <b>DC ACCURACY</b>  |                        |                |   |
| Resolution  | 8                      | Bits           |   |
| Relative Accuracy <sup>1</sup>                                  | ±0.5                   | LSB max        |   |
| Differential Nonlinearity (DNL) <sup>1</sup>                    | ±0.5                   | LSB max        |   |
| Gain Error <sup>1</sup>   | ±1                     | LSB max        |   |
| Offset Error <sup>1</sup>                                       | ±1                     | LSB max        |   |
| Total Unadjusted Error <sup>1</sup>                             | ±1                     | LSB max        |   |
| Minimum Resolution for Which<br>No Missing Codes Are Guaranteed | 8                      | Bits           |   |
| <b>ANALOG INPUT</b>   |                        |                |   |
| Input Voltage Range   | 0<br>V <sub>REF</sub>  | V min<br>V max |   |
| Input Leakage Current <sup>2</sup>                              | ±1                     | µA max         |   |
| Input Capacitance <sup>2</sup>                                  | 15                     | pF max         |   |
| <b>REFERENCE INPUTS<sup>2</sup></b>                             |                        |                |   |
| V <sub>REF</sub> Input Voltage Range                            | 1.2<br>V <sub>DD</sub> | V min<br>V max |   |
| Input Leakage Current   | ±1                     | µA max         |   |
| Input Capacitance   | 20                     | pF max         |   |
| <b>LOGIC INPUTS<sup>2</sup></b>                                 |                        |                |   |
| V <sub>INH</sub> , Input High Voltage                           | 2.0                    | V min          |   |
| V <sub>INL</sub> , Input Low Voltage                            | 0.4                    | V max          |   |
| Input Current, I <sub>IN</sub>                                  | ±1                     | µA max         | Typically 10 nA, V <sub>IN</sub> = 0 V to V <sub>DD</sub> |
| Input Capacitance, C <sub>IN</sub>                              | 8                      | pF max         |   |
| <b>LOGIC OUTPUTS</b>  |                        |                |   |
| Output High Voltage, V <sub>OH</sub>                            | 2.4                    | V min          | I <sub>SOURCE</sub> = 200 µA                              |
| Output Low Voltage, V <sub>OL</sub>                             | 0.4                    | V max          | I <sub>SINK</sub> = 200 µA                                |
| High Impedance Leakage Current                                  | ±1                     | µA max         |   |
| High Impedance Capacitance                                      | 15                     | pF max         |   |
| <b>CONVERSION RATE</b>  |                        |                |   |
| Conversion Time   | 4                      | µs typ         |   |
| Track/Hold Acquisition Time <sup>1</sup>                        | 100                    | ns max         | See DC Acquisition Section                                |
| <b>POWER SUPPLY</b>   |                        |                |   |
| V <sub>DD</sub>   | 2.7–5.5                | Volts          | For Specified Performance                                 |
| I <sub>DD</sub>   | 3.5                    | mA max         | Sampling at 133 kSPS and Logic                            |
| Power Dissipation   | 17.5                   | mW max         | Inputs @ V <sub>DD</sub> or 0 V. V <sub>DD</sub> = 5 V    |
| Power-Down Mode   |                        |                | Nominal Supplies  |
| I <sub>DD</sub>   | 1                      | µA max         |   |
| Power Dissipation   | 5                      | µW max         | Nominal Supplies  |
| Automatic Power Down  |                        |                | V <sub>DD</sub> = 3 V                                     |
| 1 kSPS Throughput   | 54                     | µW max         |   |
| 10 kSPS Throughput  | 540                    | µW max         |   |
| 50 kSPS Throughput  | 2.7                    | mW max         |   |

## NOTES

<sup>1</sup>See Terminology.

<sup>2</sup>Sample tested during initial release and after any redesign or process change that may affect this parameter.

Specifications subject to change without notice.

## TIMING CHARACTERISTICS<sup>1, 2</sup> (–40°C to +125°C, unless otherwise noted)

| Parameter                      | V <sub>DD</sub> = 5 V ± 10% | V <sub>DD</sub> = 3 V ± 10% | Unit     | Conditions/Comments                                   |
|--------------------------------|-----------------------------|-----------------------------|----------|---|
| t <sub>1</sub>                 | 5                           | 5                           | μs (max) | Conversion Time Mode 1 Operation (High Speed Mode)    |
| t <sub>2</sub>                 | 20                          | 20                          | ns (min) | CONVST Pulsewidth                                     |
| t <sub>3</sub>                 | 25                          | 25                          | ns (min) | SCLK High Pulsewidth                                  |
| t <sub>4</sub>                 | 25                          | 25                          | ns (min) | SCLK Low Pulsewidth                                   |
| t <sub>5</sub> <sup>3</sup>    | 5                           | 5                           | ns (min) | CONVST Rising Edge to SCLK Rising Edge Set-Up Time    |
| t <sub>6</sub> <sup>3</sup>    | 10                          | 10                          | ns (max) | SCLK Rising Edge to D <sub>OUT</sub> Data Valid Delay |
| t <sub>7</sub> <sup>3</sup>    | 5                           | 5                           | ns (max) | Data Hold Time after Rising Edge SCLK                 |
| t <sub>8</sub> <sup>3, 4</sup> | 20                          | 20                          | ns (max) | Bus Relinquish Time after Falling Edge of SCLK        |
| t <sub>POWERUP</sub>           | 1.5                         | 1.5                         | μs (max) | Power-Up Time   |

### NOTES

<sup>1</sup>Sample tested to ensure compliance.

<sup>2</sup>See Figures 14, 15 and 16.

<sup>3</sup>These numbers are measured with the load circuit of Figure 1. They are defined as the time required for the o/p to cross 0.8 V or 2.4 V for V<sub>DD</sub> = 5 V ± 10% and 0.4 V or 2 V for V<sub>DD</sub> = 3 V ± 10%.

<sup>4</sup>Derived from the measured time taken by the data outputs to change 0.5 V when loaded with the circuit of Figure 1. The measured number is then extrapolated back to remove the effects of charging or discharging the 50 pF capacitor. This means that the time quoted in the Timing Characteristics, t<sub>8</sub>, is the true bus relinquish time of the part and as such is independent of external bus loading capacitances.

Specifications subject to change without notice.

### ABSOLUTE MAXIMUM RATINGS\*

(T<sub>A</sub> = 25°C unless otherwise noted)

V<sub>DD</sub> to GND . . . . . –0.3 V to +7 V

Digital Input Voltage to GND

(CONVST, SCLK) . . . . . –0.3 V, V<sub>DD</sub> + 0.3 V

Digital Output Voltage to GND

(D<sub>OUT</sub>) . . . . . –0.3 V, V<sub>DD</sub> + 0.3 V

V<sub>REF</sub> to GND . . . . . –0.3 V, V<sub>DD</sub> + 0.3 V

Analog Inputs

(V<sub>IN+</sub>, V<sub>IN-</sub>) . . . . . –0.3 V, V<sub>DD</sub> + 0.3 V

Storage Temperature Range . . . . . –65°C to +150°C

Junction Temperature . . . . . 150°C

Plastic DIP Package, Power Dissipation . . . . . 450 mW

θ<sub>JA</sub> Thermal Impedance . . . . . 125°C/W

θ<sub>JC</sub> Thermal Impedance . . . . . 50°C/W

Lead Temperature, Soldering (10 sec) . . . . . 260°C

SOIC Package, Power Dissipation . . . . . 450 mW

θ<sub>JA</sub> Thermal Impedance . . . . . 160°C/W

θ<sub>JC</sub> Thermal Impedance . . . . . 56°C/W

Lead Temperature, Soldering

Vapor Phase (60 sec) . . . . . 215°C

Infrared (15 sec) . . . . . 220°C

MicroSOIC Package, Power Dissipation . . . . . 450 mW

θ<sub>JA</sub> Thermal Impedance . . . . . 206°C/W

θ<sub>JC</sub> Thermal Impedance . . . . . 44°C/W

Lead Temperature, Soldering

Vapor Phase (60 sec) . . . . . 215°C

Infrared (15 sec) . . . . . 220°C

\*Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### ORDERING GUIDE

| Model     | Linearity Error | Temperature Range | Branding Information | Package Option* |
|-----------|-----------------|-------------------|----------------------|-----------------|
| AD7823YN  | ±1 LSB          | –40°C to +125°C   |                      | N-8             |
| AD7823YR  | ±1 LSB          | –40°C to +125°C   |                      | SO-8            |
| AD7823YRM | ±1 LSB          | –40°C to +125°C   | C2Y                  | RM-8            |

\*N = plastic DIP; RM = microSOIC; SO = small outline IC (SOIC).

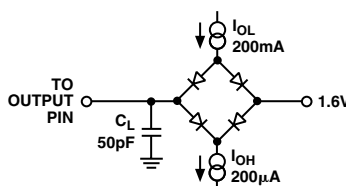


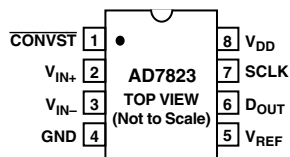
Figure 1. Load Circuit for Digital Output Timing Specifications

# AD7823

## PIN FUNCTION DESCRIPTIONS

| Pin No. | Mnemonic                   | Description  |
|---------|----------------------------|--|
| 1       | $\overline{\text{CONVST}}$ | Convert Start. Falling edge puts the track-and-hold into hold mode and initiates a conversion. A rising edge on the $\overline{\text{CONVST}}$ pin enables the serial port of the AD7823. This is useful in multipackage applications where a number of devices share the same serial bus. The state of this pin at the end of conversion also determines whether the part is powered down or not. See Operating Modes section of this data sheet. |
| 2       | $V_{\text{IN}+}$           | Positive input of the pseudo differential analog input.  |
| 3       | $V_{\text{IN}-}$           | Negative input of the pseudo differential analog input.  |
| 4       | GND                        | Ground reference for analog and digital circuitry.   |
| 5       | $V_{\text{REF}}$           | External reference is connected here.  |
| 6       | $D_{\text{OUT}}$           | Serial data is shifted out on this pin.  |
| 7       | SCLK                       | Serial Clock. An external serial clock is applied here.  |
| 8       | $V_{\text{DD}}$            | Positive Supply Voltage 2.7 V to 5.5 V.  |

## PIN CONFIGURATION DIP/SOIC/microSOIC



## TERMINOLOGY

### Signal to (Noise + Distortion) Ratio

This is the measured ratio of signal to (noise + distortion) at the output of the A/D converter. The signal is the rms amplitude of the fundamental. Noise is the rms sum of all nonfundamental signals up to half the sampling frequency ( $f_s/2$ ), excluding dc. The ratio is dependent upon the number of quantization levels in the digitization process; the more levels, the smaller the quantization noise. The theoretical signal to (noise + distortion) ratio for an ideal N-bit converter with a sine wave input is given by:

$$\text{Signal to (Noise + Distortion)} = (6.02N + 1.76) \text{ dB}$$

Thus for an 8-bit converter, this is 50 dB.

### Total Harmonic Distortion

Total harmonic distortion (THD) is the ratio of the rms sum of harmonics to the fundamental. For the AD7823 it is defined as:

$$\text{THD (dB)} = 20 \log \frac{\sqrt{V_2^2 + V_3^2 + V_4^2 + V_5^2 + V_6^2}}{V_1}$$

where  $V_1$  is the rms amplitude of the fundamental and  $V_2$ ,  $V_3$ ,  $V_4$ ,  $V_5$  and  $V_6$  are the rms amplitudes of the second through the sixth harmonics.

### Peak Harmonic or Spurious Noise

Peak harmonic or spurious noise is defined as the ratio of the rms value of the next largest component in the ADC output spectrum (up to  $f_s/2$  and excluding dc) to the rms value of the fundamental. Normally, the value of this specification is determined by the largest harmonic in the spectrum, but for parts where the harmonics are buried in the noise floor, it will be a noise peak.

### Intermodulation Distortion

With inputs consisting of sine waves at two frequencies,  $f_a$  and  $f_b$ , any active device with nonlinearities will create distortion products at sum and difference frequencies of  $m f_a \pm n f_b$  where  $m, n = 0, 1, 2, 3$ , etc. Intermodulation terms are those for which neither  $m$  nor  $n$  are equal to zero. For example, the second order terms include  $(f_a + f_b)$  and  $(f_a - f_b)$ , while the third order terms include  $(2f_a + f_b)$ ,  $(2f_a - f_b)$ ,  $(f_a + 2f_b)$  and  $(f_a - 2f_b)$ .

The AD7823 is tested using the CCIF standard where two input frequencies near the top end of the input bandwidth are used. In this case, the second and third order terms are of different significance. The second order terms are usually distanced in frequency from the original sine waves while the third order terms are usually at a frequency close to the input frequencies. As a result, the second and third order terms are specified separately. The calculation of the intermodulation distortion is as per the THD specification where it is the ratio of the rms sum of the individual distortion products to the rms amplitude of the fundamental expressed in dBs.

### Relative Accuracy

Relative accuracy or endpoint nonlinearity is the maximum deviation from a straight line passing through the endpoints of the ADC transfer function.

### Differential Nonlinearity

This is the difference between the measured and the ideal 1 LSB change between any two adjacent codes in the ADC.

### Offset Error

This is the deviation of the first code transition (0000 . . . 000) to (0000 . . . 001) from the ideal, i.e., AGND + 1 LSB.

### Gain Error

This is the deviation of the last code transition (1111 . . . 110) to (1111 . . . 111) from the ideal (i.e.,  $V_{REF} - 1$  LSB) after the offset error has been adjusted out.

### Track/Hold Acquisition Time

Track/hold acquisition time is the time required for the output of the track/hold amplifier to reach its final value, within  $\pm 1/2$  LSB, after the end of conversion (the point at which the track/hold returns to track mode). It also applies to situations where there is a step input change on the input voltage applied to the  $V_{IN+}$  input of the AD7823. It means that the user must wait for the duration of the track/hold acquisition time, after the end of conversion or after a step input change to  $V_{IN}$ , before starting another conversion to ensure that the part operates to specification.

## Typical Performance Characteristics

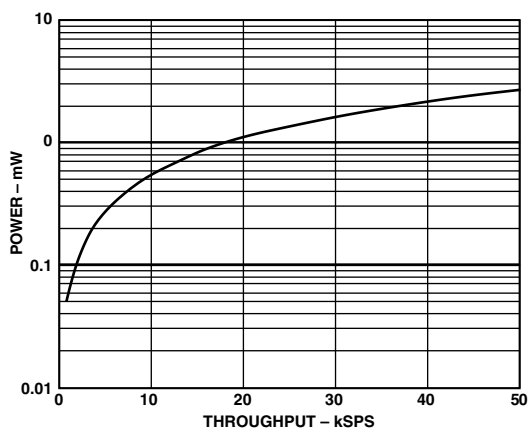


Figure 2. Power vs. Throughput

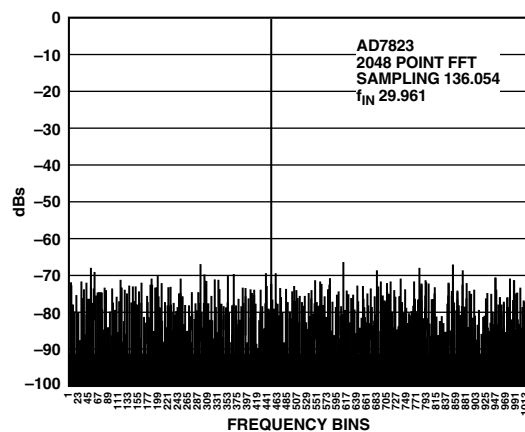


Figure 3. AD7823 SNR

# AD7823

## CIRCUIT DESCRIPTION

### Converter Operation

The AD7823 is a successive approximation analog-to-digital converter based around a charge redistribution DAC. The ADC can convert analog input signals in the range 0 V to  $V_{DD}$ . Figures 4 and 5 below show simplified schematics of the ADC. Figure 4 shows the ADC during its acquisition phase. SW2 is closed and SW1 is in Position A; the comparator is held in a balanced condition; and the sampling capacitor acquires the signal on  $V_{IN+}$ .

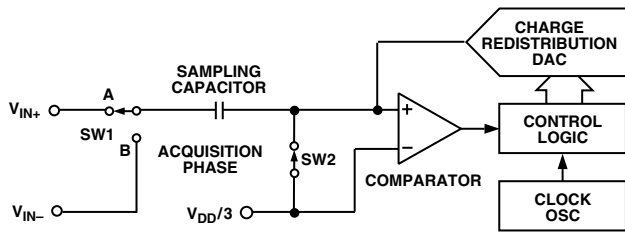


Figure 4. ADC Acquisition Phase

When the ADC starts a conversion (see Figure 5) SW2 will open, and SW1 will move to Position B causing the comparator to become unbalanced. The control logic and the charge redistribution DAC are used to add and subtract fixed amounts of charge from the sampling capacitor in order to bring the comparator back into a balanced condition. When the comparator is rebalanced, the conversion is complete. The control logic generates the ADC output code. Figure 11 shows the ADC transfer function.

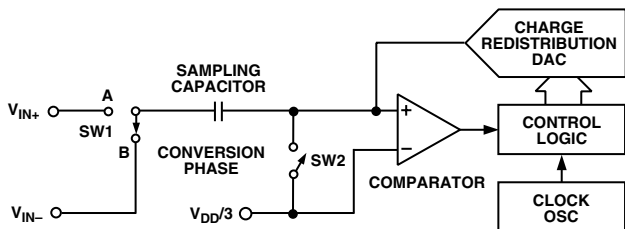


Figure 5. ADC Conversion Phase

### TYPICAL CONNECTION DIAGRAM

Figure 6 shows a typical connection diagram for the AD7823. The serial interface is implemented using two wires; the rising edge of  $\overline{CONVST}$  enables the serial interface—see Serial Interface section for more details.  $V_{REF}$  is connected to a well decoupled  $V_{DD}$  pin to provide an analog input range of 0 V to  $V_{DD}$ . When  $V_{DD}$  is first connected, the AD7823 powers up in a low current mode, i.e., power-down. A rising edge on the  $\overline{CONVST}$  input will cause the part to power up—see Operating Modes. If power consumption is of concern, the automatic power-down at the end of a conversion should be used to improve power performance. See Power vs. Throughput Rate section of the data sheet.

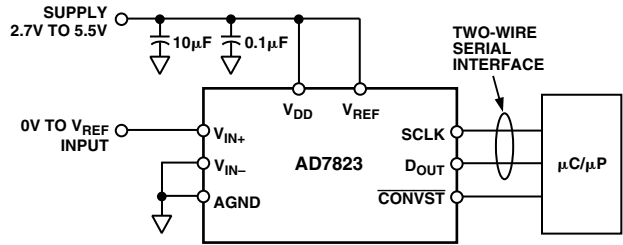


Figure 6. Typical Connection Diagram

### Analog Input

Figure 7 shows an equivalent circuit of the analog input structure of the AD7823. The two diodes, D1 and D2, provide ESD protection for the analog inputs. Care must be taken to ensure that the analog input signal never exceeds the supply rails by more than 200 mV. This will cause these diodes to become forward biased and start conducting current into the substrate. The maximum current these diodes can conduct without causing irreversible damage to the part is 20 mA. The capacitor C2 is typically about 4 pF and can be primarily attributed to pin capacitance. The resistor R1 is a lumped component made up of the on resistance of a multiplexer and a switch. This resistor is typically about 125  $\Omega$ . The capacitor C1 is the ADC sampling capacitor and has a capacitance of 3.5 pF.

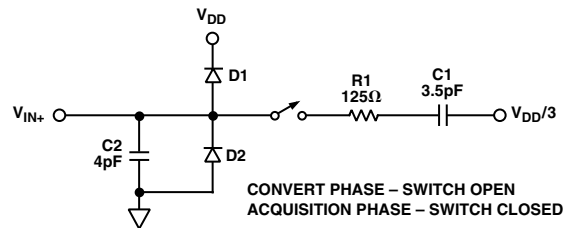


Figure 7. Equivalent Analog Input Circuit

The analog input of the AD7823 is made up of a pseudo differential pair,  $V_{IN+}$  pseudo differential with respect to  $V_{IN-}$ . The signal is applied to  $V_{IN+}$  but in the pseudo differential scheme the sampling capacitor is connected to  $V_{IN-}$  during conversion—see Figure 8. This input scheme can be used to remove offsets that exist in a system. For example, if a system had an offset of 0.5 V, the offset could be applied to  $V_{IN-}$  and the signal applied to  $V_{IN+}$ . This has the effect of offsetting the input span by 0.5 V. It is only possible to offset the input span when the reference voltage ( $V_{REF}$ ) is less than  $V_{DD} - V_{OFFSET}$ .

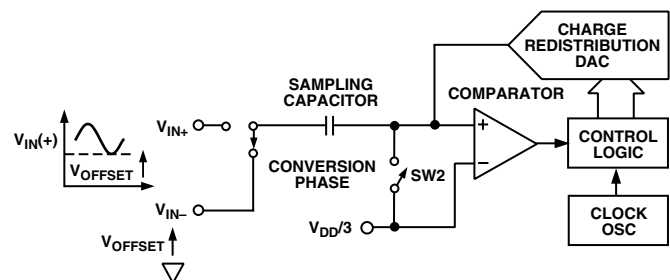


Figure 8. Pseudo Differential Input Scheme

When using the pseudo differential input scheme the signal on  $V_{IN-}$  must not vary by more than a 1/2 LSB during the conversion process. If the signal on  $V_{IN-}$  varies during conversion, the conversion result will be incorrect. For single ended operation,  $V_{IN-}$  is always connected to AGND. Figure 9 shows the AD7823 pseudo differential input being used to make a unipolar dc current measurement. A sense resistor is used to convert the current to a voltage, and the voltage is applied to the differential input as shown.

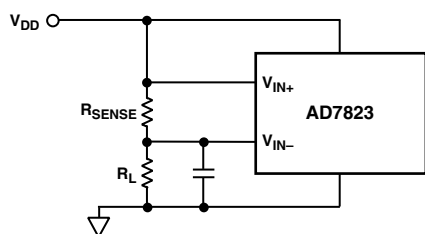


Figure 9. DC Current Measurement Scheme

### DC Acquisition Time

The ADC starts a new acquisition phase at the end of a conversion and ends on the falling edge of the  $\overline{\text{CONVST}}$  signal. At the end of a conversion there is a settling time associated with the sampling circuit. This settling time lasts approximately 100 ns. The analog signal on  $V_{IN+}$  is also being acquired during this settling time; therefore, the minimum acquisition time needed is approximately 100 ns.

Figure 10 shows the equivalent charging circuit for the sampling capacitor when the ADC is in its acquisition phase.  $R_2$  represents the source impedance of a buffer amplifier or resistive network;  $R_1$  is an internal multiplexer resistance and  $C_1$  is the sampling capacitor.

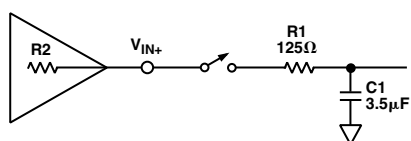


Figure 10. Equivalent Sampling Circuit

During the acquisition phase, the sampling capacitor must be charged to within a 1/2 LSB of its final value. The time it takes to charge the sampling capacitor ( $t_{\text{CHARGE}}$ ) is given by the following formula:

$$t_{\text{CHARGE}} = 6.2 \times (R_2 + 125 \Omega) \times 3.5 \text{ pF}$$

For small values of source impedance, the settling time associated with the sampling circuit (100 ns) is, in effect, the acquisition time of the ADC. For example, with a source impedance ( $R_2$ ) of 10  $\Omega$ , the charge time for the sampling capacitor is approximately 2 ns. The charge time becomes significant for source impedances of 4.6 k $\Omega$  and greater.

### AC Acquisition Time

In ac applications it is recommended to always buffer analog input signals. The source impedance of the drive circuitry must be kept as low as possible to minimize the acquisition time of the ADC. Large values of source impedance will cause the THD to degrade at high throughput rates. In addition, better performance can generally be achieved by using an external 1 nF capacitor on  $V_{IN+}$ .

### ADC TRANSFER FUNCTION

The output coding of the AD7823 is straight binary. The designed code transitions occur at successive integer LSB values (i.e., 1 LSB, 2 LSBs, etc.). The LSB size is  $= V_{\text{REF}}/256$ . The ideal transfer characteristic for the AD7823 is shown in Figure 11 below.

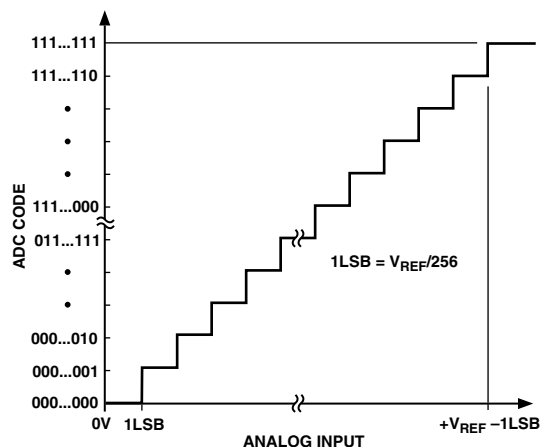


Figure 11. Transfer Characteristic



# AD7823

## POWER-UP TIMES

The AD7823 has a 1.5  $\mu\text{s}$  power-up time. When  $V_{DD}$  is first connected, the AD7823 is in a low current mode of operation. In order to carry out a conversion, the AD7823 must first be powered up. The ADC is powered up by a rising edge on the  $\overline{\text{CONVST}}$  pin. A conversion is initiated on the falling edge of  $\overline{\text{CONVST}}$ . Figure 12 shows how to power up the AD7823 when  $V_{DD}$  is first connected or after the AD7823 is powered down using the  $\overline{\text{CONVST}}$  pin.

Care must be taken to ensure that the  $\overline{\text{CONVST}}$  pin of the AD7823 is logic low when  $V_{DD}$  is first applied.

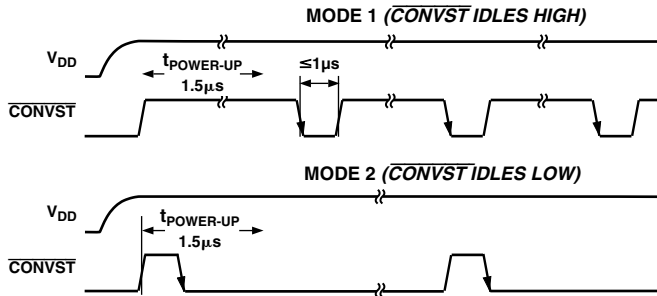


Figure 12. Power-Up Times

## POWER VS. THROUGHPUT RATE

By operating the AD7823 in Mode 2, the average power consumption of the AD7823 decreases at lower throughput rates. Figure 13 shows how the automatic power-down is implemented using the  $\overline{\text{CONVST}}$  signal to achieve the optimum power performance for the AD7823. The AD7823 is operated in Mode 2. As the throughput rate is reduced, the device remains in its power-down state for longer, and the average power consumption over time drops accordingly.

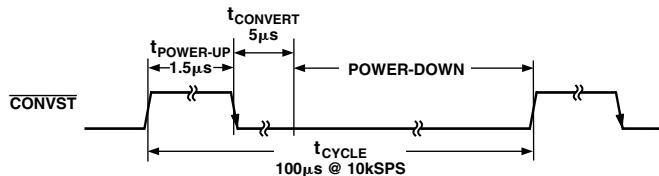


Figure 13. Automatic Power-Down

For example, if the AD7823 is operated in a continuous sampling mode with a throughput rate of 10 kSPS, the power consumption is calculated as follows. The power dissipation during normal operation is 10.5 mW,  $V_{DD} = 3$  V. If the power-up time is 1.5  $\mu\text{s}$  and the conversion time is 5  $\mu\text{s}$ , then the AD7823 can be said to dissipate 10.5 mW for 6.5  $\mu\text{s}$  (worst case) during each conversion cycle. If the throughput rate is 10 kSPS, the cycle time is 100  $\mu\text{s}$ , and the average power dissipated during each cycle is  $(6.5/100) \times (10.5 \text{ mW}) = 683 \mu\text{W}$ . Figure 2 shows a graph of Power vs. Throughput.

## OPERATING MODES

### Mode 1 Operation (High Speed Sampling)

When the AD7823 is used in this mode of operation, the part is not powered down between conversions. This mode of operation allows high throughput rates to be achieved. The timing diagram in Figure 14 shows how this optimum throughput rate is achieved by bringing the  $\overline{\text{CONVST}}$  signal high before the end of the conversion. It is recommended that the  $\overline{\text{CONVST}}$  signal should go high within 3  $\mu\text{s}$  of conversion starting. This ensures that the  $\overline{\text{CONVST}}$  signal does not go high at the same time the part is attempting to power down. The AD7823 leaves its tracking mode and goes into hold on the falling edge of  $\overline{\text{CONVST}}$ . A conversion is also initiated at this time and takes 4  $\mu\text{s}$  typ to complete. At this point, the result of the current conversion is latched into the serial shift register, and the state of the  $\overline{\text{CONVST}}$  signal is checked. The  $\overline{\text{CONVST}}$  signal should be high at the end of the conversion to prevent the part from powering down.

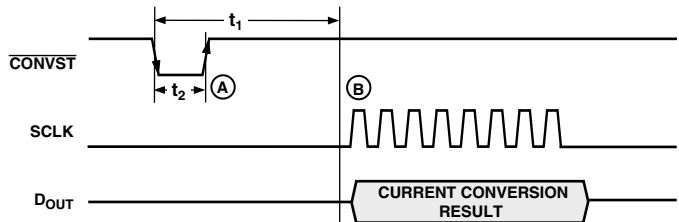


Figure 14. Mode 1 Operation Timing

The serial port on the AD7823 is enabled on the rising edge of the  $\overline{\text{CONVST}}$  signal—see Serial Interface section. As explained earlier, this rising edge should occur before the end of the conversion process if the part is not to be powered down. A serial read can take place at any stage after the rising edge of  $\overline{\text{CONVST}}$ . If a serial read is initiated before the end of the current conversion process (i.e., at time “A”), then the result of the previous conversion is shifted out on the  $D_{OUT}$  pin. It is possible to allow the serial read to extend beyond the end of a conversion. In this case, the new data will not be latched into the output shift register until the read has finished. If the user waits until the end of the conversion process, i.e., 4  $\mu\text{s}$  typ after falling edge of  $\overline{\text{CONVST}}$  (Point “B”), before initiating a read, the current conversion result is shifted out.

### Mode 2 Operation (Automatic Power-Down)

When used in this mode of operation, the part automatically powers down at the end of a conversion. This is achieved by leaving the  $\overline{\text{CONVST}}$  signal low until the end of the conversion. The timing diagram in Figure 15 shows how to operate the part in this mode. If the AD7823 is powered down, the rising edge of the  $\overline{\text{CONVST}}$  pulse causes the part to power up. When the part has powered up ( $\approx 1.5 \mu\text{s}$  after the rising edge of  $\overline{\text{CONVST}}$ ), the  $\overline{\text{CONVST}}$  signal is brought low, and a conversion is initiated on this falling edge of the  $\overline{\text{CONVST}}$  signal. The conversion takes  $5 \mu\text{s}$  max and after this time, the conversion result is latched into the serial shift register and the part powers down. Therefore, when the part is operated in Mode 2, the effective conversion time is equal to the power-up time ( $1.5 \mu\text{s}$ ) and the SAR conversion time ( $5 \mu\text{s}$ ), i.e.,  $6.5 \mu\text{s}$ .

As in the case of Mode 1 operation, the rising edge of the  $\overline{\text{CONVST}}$  pulse enables the serial port of the AD7823—see Serial Interface section. If a serial read is initiated soon after this rising edge (Point “A”), i.e., before the end of the conversion, then the result of the previous conversion is shifted out on pin  $\text{D}_{\text{OUT}}$ . In order to read the result of the current conversion, the user must wait at least  $5 \mu\text{s}$  max after the falling edge of  $\overline{\text{CONVST}}$  before initiating a serial read. The serial port of the AD7823 is still functional even though the AD7823 has been powered down. Note: A serial read should not cross the reset rising edge of  $\overline{\text{CONVST}}$ .

Because it is possible to do a serial read from the part while it is powered down, the AD7823 is powered up only to do the conversion and is immediately powered down at the end of a conversion. This significantly improves the power consumption of the part at slower throughput rates—see Power vs. Throughput Rate section.

Note: Although the AD7823 takes  $1.5 \mu\text{s}$  to power up after the rising edge of  $\overline{\text{CONVST}}$ , it is not necessary to leave  $\overline{\text{CONVST}}$

high for  $1.5 \mu\text{s}$  after the rising edge before bringing it low to initiate a conversion. If the  $\overline{\text{CONVST}}$  signal goes low before  $1.5 \mu\text{s}$  in time has elapsed, the power-up time is timed out internally and a conversion is initiated. Hence the AD7823 is guaranteed to have always powered up before a conversion is initiated—even if the  $\overline{\text{CONVST}}$  pulsewidth is  $<1.5 \mu\text{s}$ . If the  $\overline{\text{CONVST}}$  width is  $>1.5 \mu\text{s}$  a conversion is initiated on the falling edge.

### SERIAL INTERFACE

The serial interface of the AD7823 consists of three wires, a serial clock input SCLK, serial port enable  $\overline{\text{CONVST}}$  and a serial data output  $\text{D}_{\text{OUT}}$ , see Figure 16 below. The serial interface is designed to allow easy interfacing to most microcontrollers, e.g., PIC16C, PIC17C, QSPI and SPI, without the need for any gluing logic. When interfacing to the 8051, the SCLK must be inverted. The “Microprocessor Interface” section explains how to interface to some popular microcontrollers.

Figure 16 shows the timing diagram for a serial read from the AD7823. The serial interface works with both a continuous and a noncontinuous serial clock. The rising edge of the  $\overline{\text{CONVST}}$  signal RESETS a counter, which counts the number of serial clocks to ensure the correct number of bits are shifted out of the serial shift registers. The SCLK is ignored once the correct number of bits have been shifted out. In order for another serial transfer to take place, the counter must be reset by the falling edge of the eighth SCLK. Data is clocked out from the  $\text{D}_{\text{OUT}}$  line on the first rising SCLK edge after the rising edge of the  $\overline{\text{CONVST}}$  signal and on subsequent SCLK rising edges. The  $\text{D}_{\text{OUT}}$  pin goes back into a high impedance state on the falling edge of the eighth SCLK. In multipackage applications, the  $\overline{\text{CONVST}}$  signal can be used as a chip select signal. The serial interface will not shift data out until it receives a rising edge on the  $\overline{\text{CONVST}}$  pin.

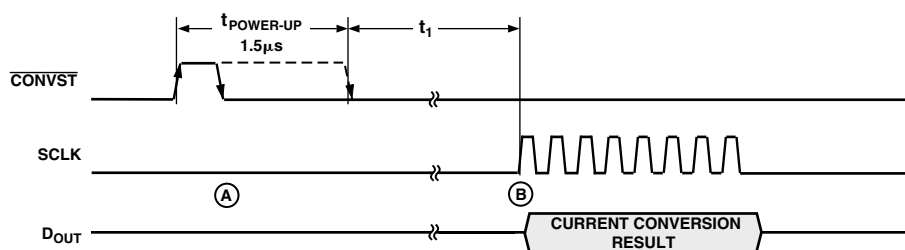


Figure 15. Mode 2 Operation Timing

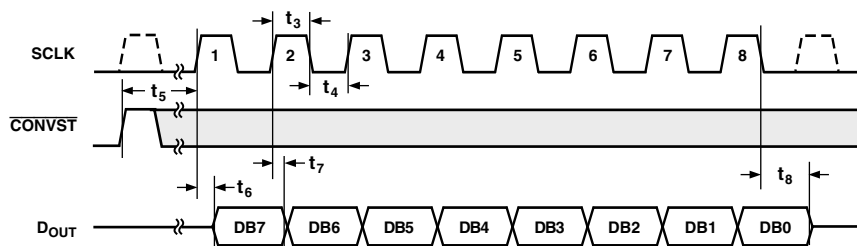


Figure 16. Serial Interface Timing

# AD7823

## MICROPROCESSOR INTERFACING

The serial interface on the AD7823 allows the parts to be directly connected to a range of many different microprocessors. This section explains how to interface the AD7823 with some of the more common microcontroller serial interface protocols.

### AD7823 to PIC16C6x/7x

The PIC16C6x Synchronous Serial Port (SSP) is configured as an SPI Master with the Clock Polarity Bit = 0. This is done by writing to the Synchronous Serial Port Control Register (SSPCON). See *PIC16/17 Microcontroller User Manual*. Figure 17 shows the hardware connections needed to interface to the PIC16/PIC17. In this example I/O port RA1 is being used to pulse  $\overline{\text{CONVST}}$  and enable the serial port of the AD7823.

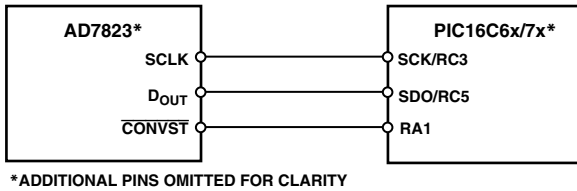


Figure 17. Interfacing to the PIC16/PIC17

### AD7823 to MC68HC11

The Serial Peripheral Interface (SPI) on the MC68HC11 is configured for Master Mode (MSTR = 0), Clock Polarity Bit (CPOL) = 0, and the Clock Phase Bit (CPHA) = 1. The SPI is configured by writing to the SPI Control Register (SPCR)—see *68HC11 User Manual*. A connection diagram is shown in Figure 18.

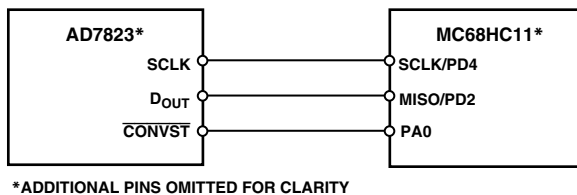


Figure 18. Interfacing to the MC68HC11

### AD7823 to 8051

The AD7823 requires a clock synchronized to the serial data; therefore, the 8051 serial interface must be operated in Mode 0. In this mode serial data enters and exits through RXD, and a serial clock is output on TXD (half duplex). Figure 19 shows how the 8051 is connected to the AD7823. Here, because the AD7823 shifts data out on the rising edge of the serial clock, the serial clock must be inverted.

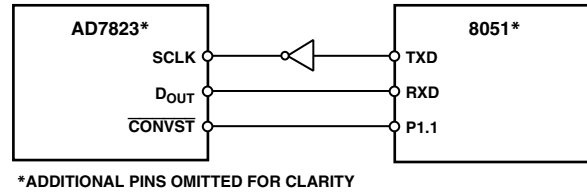


Figure 19. Interfacing to the 8051 Serial Port

It is possible to implement a serial interface using the data ports on the 8051 (or any microcontroller). This would allow direct interfacing between the AD7823 and 8051 to be implemented without the need for any “gluing” logic. The technique involves “bit banging” an I/O port (e.g., P1.0) to generate a serial clock and using another I/O port (e.g., P1.1) to read in data, see Figure 20.

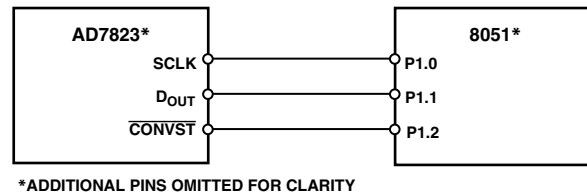
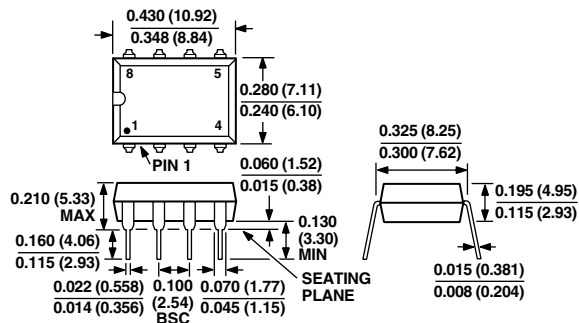


Figure 20. Interfacing to the 8051 Using I/O Ports

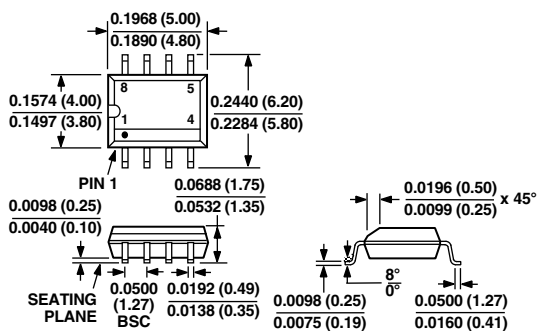
**OUTLINE DIMENSIONS**

Dimensions shown in inches and (mm).

**8-Lead Plastic DIP  
(N-8)**



**8-Lead Small Outline Package  
(SO-8)**



**8-Lead microSOIC Package  
(RM-8)**

